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FQA7N60



FQA7N60 600V N-Channel MOSFET

General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supply.

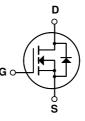
Features

+ 7.7A, 600V, $R_{DS(on)}$ = 1.0 Ω @V_{GS} = 10 V + Low gate charge (typical 29 nC)

April 2000

FET™

- Low Crss (typical 16 pF)
- · Fast switching
- 100% avalanche tested
- · Improved dv/dt capability
- TO-3P GDS FQA Series



Absolute Maximum Ratings $T_{c} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		FQA7N60	Units
V _{DSS}	Drain-Source Voltage		600	V
I _D	Drain Current - Continuous (T _C = 25°	C)	7.7	Α
	- Continuous (T _C = 100°C)		4.8	Α
I _{DM}	Drain Current - Pulsed	(Note 1)	30.8	А
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	580	mJ
I _{AR}	Avalanche Current	(Note 1)	7.7	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	15.2	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns
PD	Power Dissipation (T _C = 25°C) - Derate above 25°C		152	W
			1.22	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
ΤL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		0.82	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink	0.24		°C/W
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient		40	°C/W

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$	600			V
ΔΒV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu A$, Referenced to 25°C	;	0.67		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			10	μA
		V _{DS} = 480 V, T _C = 125°C			100	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			-100	nA
On Cha	aracteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3.9 \text{ A}$		0.8	1.0	Ω
9 _{FS}	Forward Transconductance	$V_{DS} = 50 \text{ V}, I_D = 3.9 \text{ A}$ (Note 4		6.5		S
	ic Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$		1100	1430	pF
C _{oss}	Output Capacitance	f = 1.0 MHz		135	175	pF
C _{rss}	Reverse Transfer Capacitance			16	21	pF
Switch	ing Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 300 V, I _D = 7.4 A,		30	70	ns
t _r	Turn-On Rise Time	$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 7.4 \text{ A},$ R _G = 25 Ω		80	170	ns
t _{d(off)}	Turn-Off Delay Time			65	140	ns
t _f	Turn-Off Fall Time	(Note 4, 5	i)	60	130	ns
Qg	Total Gate Charge	V _{DS} = 480 V, I _D = 7.4 A,		29	38	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V		7		nC
Q _{ad}	Gate-Drain Charge	(Note 4, 5	j)	14.5		nC

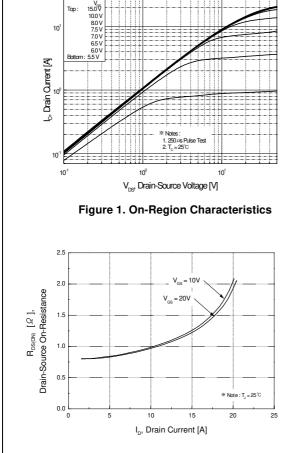
۱ _S	Maximum Continuous Drain-Source Diode Forward Current				7.7	A
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				30.8	А
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 7.7 A			1.4	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V, I_S = 7.4 A,$		320		ns
Q _{rr}	Reverse Recovery Charge	$dI_F / dt = 100 \text{ A/}\mu\text{s}$ (Note 4)		2.4		μC

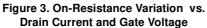
Notes: 1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 18mH, I_{AS} = 7.7A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C 3. I_{SD} = 7.4A, di/dt $\leq 200A\mu$ s, V_{DD} $\leq 8V_{DSS}$ Starting T_J = 25°C 4. Pulse Test : Pulse width $\leq 300\mu$ s, Duty cycle $\leq 2\%$ 5. Essentially independent of operating temperature

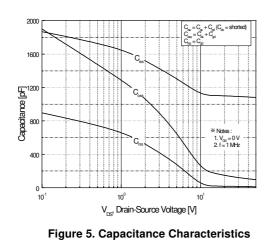
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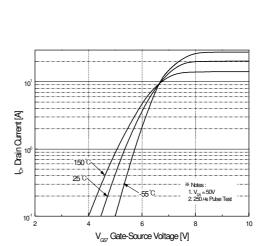


Typical Characteristics

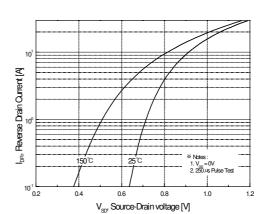


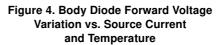


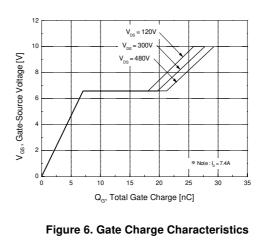






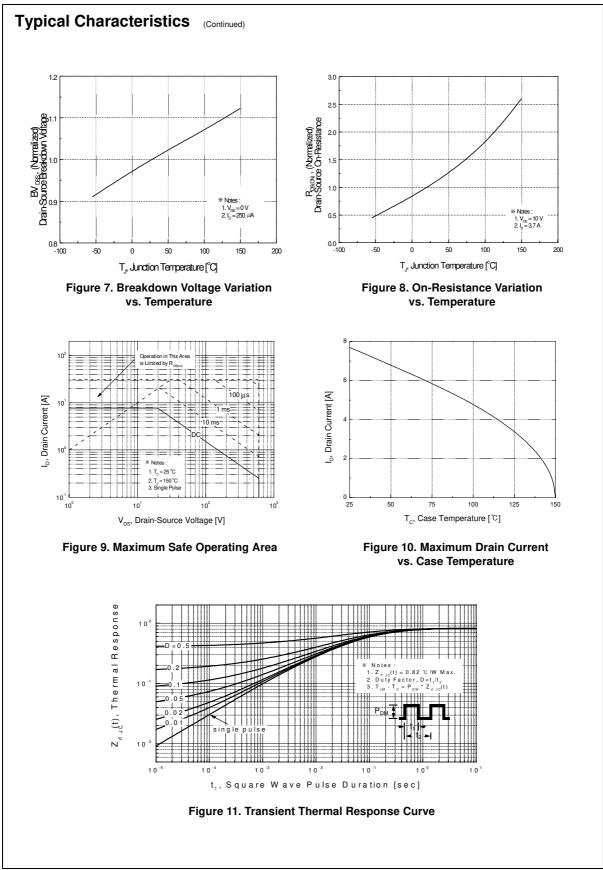




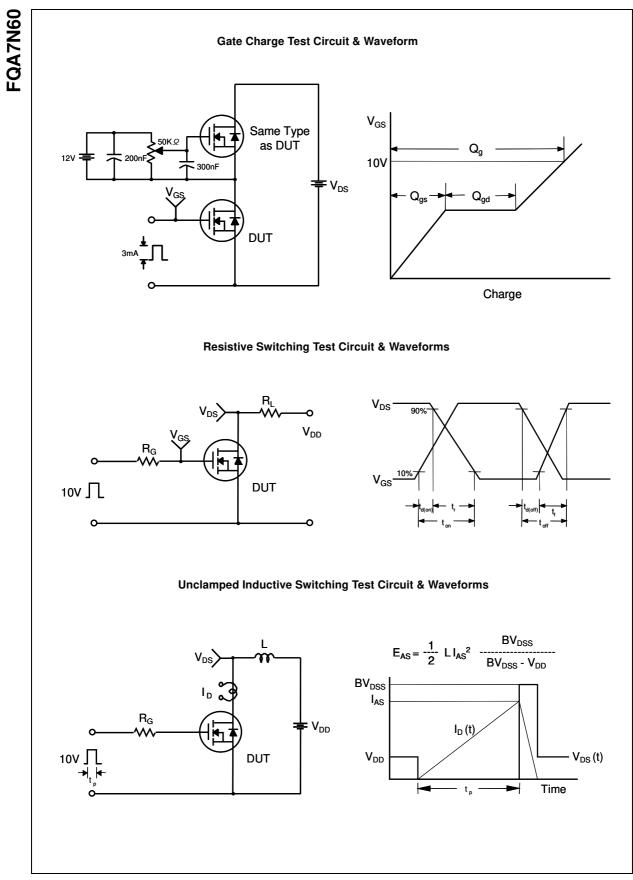




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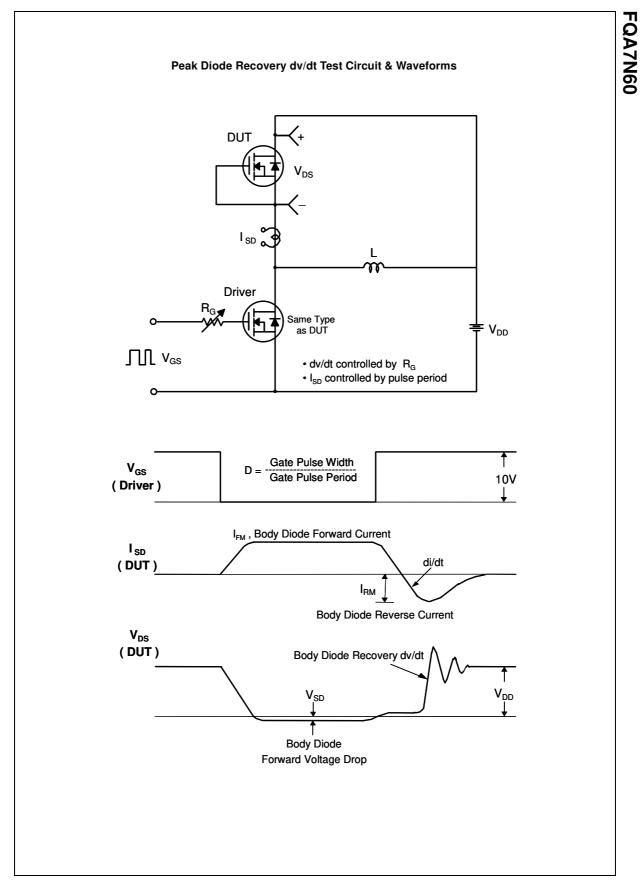


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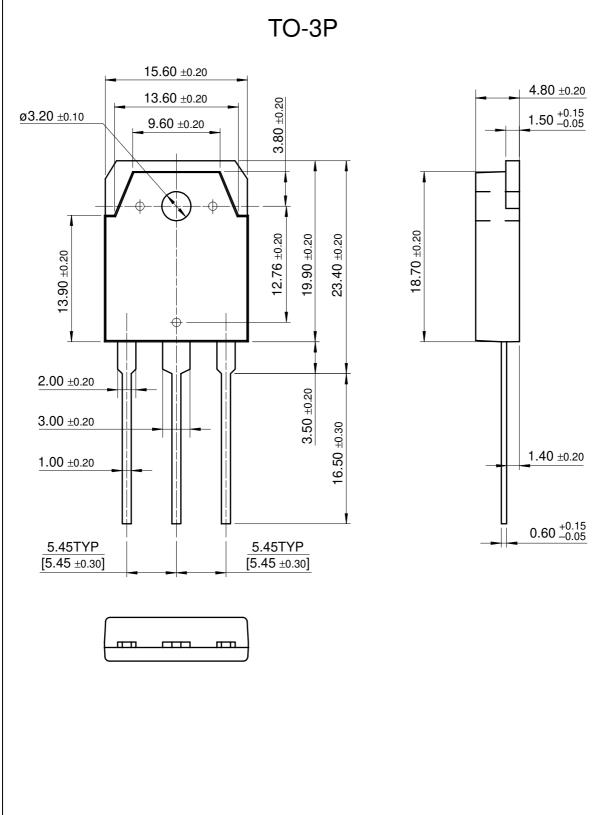


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Package Dimensions



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